

# We are present at productronica 2017



# Visit us 14-17 November Messe München

Please mark your calendar and give us a call or an email with your interest and planned attendance, in order for us to book time slots for demos/meetings at the specific suppliers' booths.

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Please see NEWS & HIGHLIGHTS of our machines and tools presented at the exhibition, including supplier booth numbers. Click on the headlines for more information.

# News & Highlights at productronica 2017

# **Tools for Design & Verification**



**DfT &Coverage Analysis** from **Aster Technologies** (Lars Kongsted-Jensen/Jussi Räsänen) **Test line overview** 

A1.232

✓ Presenting machine, test coverage, cumulative coverage, escape rate at each step



**Embedded Test Solutions** from **Göpel electronic** (Lars Kongsted-Jensen/Jussi Räsänen)

A1.235

**SCANFLEX II Cube** - New generation of JTAG/Boundary Scan controllers for embedded board test

✓ Based on state-of-the-art multi-core processors and FPGAs for a multifunctional architecture



**Probes & Fixtures** from **Everett Charles Technologies (ECT)** (Michael Vester/Knud Vester)

A1.544

- ✓ NEW RF Coaxial Probe for up to 20GHz
- ✓ BMP-4 extended Board Marker Probe product line
- ✓ VG Mass Interconnect Series

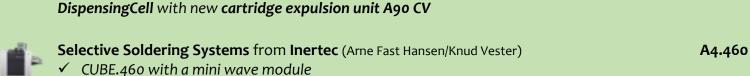


**2D/3D X-ray** from **GE (phoenix|x-ray)** (Knud Vester/Michael Vester)

A2.246

- ✓ 2D inspection with x aminer with Flash! Filters and CT option
- ✓ nanome|x with CT and planarCT
- √ nanoCT® solution for high resolution electronics CT nanotom m

Machine	es & Tools for Manufacturing	
	Bonding Machines from Hesse (Arne Fast Hansen/Knud Vester)  ✓ BJ653 - BJ855 - BJ955 - BJ985 Bonders equipped with different types of automation	B2.221
	Pick and Place from Hanwha Techwin (form. Samsung SMT) (Arne Fast Hansen/Knud Vester)  ✓ SM485P machine, various feeders and major insert components  ✓ Remote control monitoring system (T-Mobile, Tablet supported)	A3.135
	Laser Applications, Mounting, Routing, Final Assembly from OSAI (Arne Fast Hansen/Knud Vester)  ✓ Visit their booth for all their exiting news!	A3.458
<b>3</b> .*	Adhesive Bonding, Dispensing & Potting from Scheugenpflug (Arne Fast Hansen/Knud Vester)  Material feeding unit A220 Basic - New entry-level solution for high viscosity potting media	A4.454



✓ New modular system CUBE Inline+ with an ActiveFlow module

✓ Bubble-free material feed - Easy operation - High process reliability

Vapour Phase Soldering from exmore (Arne Fast Hansen/Knud Vester) A5.364

√ VS500 - renewed with Sigmatek PLC and HMI with Swipe technology

Welding on Electronics from C-Welding (Arne Fast Hansen) A2.578 New Copper Tab Battery Welder - 250i2 EV

- ✓ New motorized weld head Greater control, precision and uniformity to every weld
- ✓ Solderless connections Metals fused together for a continuous connection & no voltage drops
- ✓ Clean weld spots Surface contaminates are burned off during welding process
- ✓ Weld dissimilar metals Weld any combination of metals, such as Copper to Aluminium

Thermal Profiling Solutions from Solderstar (Arne Fast Hansen/Knud Vester) A4.240 ✓ Auto Seeker Profile Optimisation Software - Creating the best oven profile for PCBs in seconds ✓ Wave Shuttle Systems - Proving & providing accurate monitoring for wave machines, creating.

- digital logs allowing you to perfect the wave equipment and prove performance & repeatability
- ✓ **Selective Shuttle** Monitor every type of selective solder machine
- ✓ APS-SMARTLINE Most advanced constant monitoring for the reflow process, creating a profile for every PCB made & providing fail safe production measures.

**High-end Rework** from **Zevac** (Arne Fast Hansen/Lars Kongsted-Jensen) A4.277

- ✓ ONYX29 semiautomatic rework system, upgradable to a full automatic system.
- ✓ New applications, like dip application, paste on device and reballing, can be discussed at the booth

A4.549

LAS 260 - With particularly developed safe economic fume extraction & filtration methods ✓ For capture and filtration of easily inflammable or explosive dusts and air mixtures,

**Extraction and Filtration Technologies** from **ULT** (Arne Fast Hansen/Lars Kongsted-Jensen)

occurring during surface processing of hard to handle elements, e.g. titanium.



## Track, Trace & Control Systems from Cogiscan (Arne Fast Hansen/Jussi Räsänen)

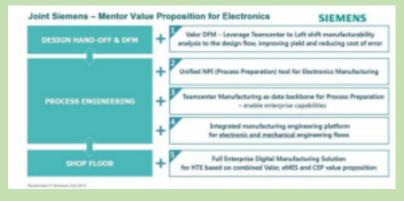
A2.361

### Factory Intelligence - New Analytics package

- ✓ Analyse metrics and KPI over a period of time
- ✓ Extensive library of ready to use dashboards and reports
- ✓ Tools to create user specific analytics
- ✓ Possible integration of Analytics data with 3. party Business Intelligence (BI) dashboard applications

## **SIEMENS** Manufacturing Execution Solution from Siemens (Arne Fast Hansen/Jussi Räsänen)

A3.434



# **Systems for Quality Assurance & Test**



# **SPI** from **Göpel electronic** (Knud Vester/Jussi Räsänen)

A1.235

✓ Very fast, world leading, innovative Dual 3D image Capturing Technology



#### **AOI** from **Göpel electronic** (Knud Vester/Jussi Räsänen)

A1.235

MagicClick – New feature on the system software PILOT AOI (presented on VarioLine)

✓ Fully automated creation and optimization of AOI test programs - in only about 3 minutes!

VarioLine · 3D - Solder joints measurements using 2D, full 3D even with 360 ° angled-view **PILOT Connect** – Industry 4.0 compliant

✓ Centralized verification of all inspection results from multiple inspection systems and types in the line



#### In-Line AXI from Göpel electronic (Knud Vester/Jussi Räsänen)

A1.235

New **StingRay X-ray detector** - additional option for X Line · 3D

- ✓ Selective 2D, 2.5D and 3D X-ray inspection of complex PCBs thanks to highly flexible image acquisition concept consisting of high-speed axes and a flat-panel detector
- ✓ Even better layer separation, brighter images with a good image quality/inspection speed balance



# Fixtureless In-Circuit Test (ICT) Flying Probe test from Takaya (Lars Kongsted-Jensen/Jussi Räsänen) A1.239

- ✓ TAKAYA APT-1400F The result of 30 years of Flying Probe Innovation!
- ▼ TAKAYA APT-1600FD-A Dual-sided Flying Probe Tester Version



#### **Probes & Fixtures** from **Everett Charles Technologies (ECT)** (Michael Vester/Knud Vester)

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# Test Coverage Measurement from Aster Technologies (Lars Kongsted-Jensen/Jussi Räsänen)

Test line overview

✓ Presenting machine, test coverage, cumulative coverage, escape rate at each step



JTAG/Boundary Scan test/ESA from Göpel electronic (Lars Kongsted-Jensen/Jussi Räsänen)

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## **2D/3D X-ray** from **GE** (phoenix|x-ray) (Knud Vester/Michael Vester)

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- ✓ x|aminer with Flash!Filters™ and CT option
- ✓ nanome|x with CT and planarCT
- ✓ CT nanotom m: The nanoCT® solution for high resolution electronics

We look forward to seeing you in Munich - hopefully also at our Nordic/Baltic networking dinner

Wednesday or Thursday evening!

Best regards,

Knud Vester Lars Kongsted-Jensen

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